

# Call for Papers

# ASMP2015

Venue and Conference Date  
Lombok Raya Hotel, Lombok Island, Indonesia  
10-13 August 2015

## Topics covered

Conference topics will be presented in oral and poster format. Oral sessions will include plenary, invited and contributed papers. Topics include but not limited to:

- Advanced Materials
- Metals, Ceramics, Polymers and Composites
- Smart Materials and Structures, Functional Materials
- Materials Processing, Forming, Casting and Machining
- Powder Metallurgy, Adhesion and Interface, Welding and Bonding
- Nanofabrication and Nano / Micro / Meso Manufacturing Processes
- Advanced Manufacturing
- Micro and Nano Technology in Materials and Processing
- Mechanical Properties, Fracture and Reliability
- Dynamic Behavior of Materials and Structures
- Materials Characterization and Measurement Techniques
- Non-Destructive Testing and Evaluations, Monitoring and Sensing Technology
- Modeling, Analysis and Simulation in Materials and Processing

## Deadlines

Submission of Abstracts :28th February 2015  
Notification of Abstract Acceptance :14th March 2015

## About ASMP2015

The 4th Asian Symposium on Materials & Processing, ASMP2015, will be held from August 10 to 13, 2015 in Lombok, Indonesia. This is the 4th in the series of ASMP (past symposiums were held in Bangkok, Thailand (1st), in Penang, Malaysia (2nd) and in Chennai, India (3rd), respectively). The aim of the symposium is to enhance mutual collaboration for higher research level and activity in the fields of Materials and Processing Engineering in Asian region. The symposium will become a perfect platform to share, discuss and exchange ideas on the latest development and recent findings in research studies related to advanced materials and processing among international participants. We would like to cordially invite you to ASMP2015.

## Registration Fee

	Early Bird (until 30th April 2015)	Normal (until 31st May 2015)	Late (until 30th June 2015)
Japanese	JPY45,000	JPY47,500	JPY52,500
Non-Japanese	USD450	USD475	USD525
Japanese Student	JPY37,500	JPY40,000	JPY45,000
Non-Japanese Student	USD375	USD400	USD450

## Conference Website

<http://www.jsme.or.jp/mpd/asmp2015/>

## Contact

ASMP2015 Secretariat, E-mail: [secretary.asmp2015@gmail.com](mailto:secretary.asmp2015@gmail.com)

## Presentation

Oral and poster sessions are planned. In the event of a large number of accepted papers, some will be assigned to poster sessions. This determination will be made by the conference committee.

## Submission of Abstract

Authors should submit an abstract NOT exceeding 300 words, no later than 28th February 2015 by e-mail to [secretary.asmp2015@gmail.com](mailto:secretary.asmp2015@gmail.com), including 1) Paper title, 2) Authors' names, 3) Affiliation, 4) Job title, 5) Mailing address, 6) Phone and fax, 7) E-mail address, and 8) Five key words. Format of abstract can be downloaded from the conference website. After reviewing process by the conference committee, authors will be notified of acceptance or rejection of their abstracts by 14th March 2015.

## Preparation of Proceeding Papers (Extended Abstract)

Conference proceedings will be published by JSME and QiR. Authors should submit the proceeding paper (2 pages including figures), no later than 15th April 2015, through the conference website. After reviewing process by the conference committee, authors will be notified of acceptance or modification of their papers. Accepted papers will appear on the ASMP2015 Conference Proceeding. Details will be available on the conference website.

## Journal Publication

Participants of ASMP2015 can submit papers to the Special Issue on the Asian Symposium on Materials and Processing (ASMP2015) of Mechanical Engineering Journal (JSME International Journal). The issue will be published in April 2016.

## Conference Committee Members

Symposium Chair:

Prof. Hideshi Miura, Kyushu University, Japan

General Chair:

Prof. Masaaki Otsu, University of Fukui, Japan

Dr. Gandjar Kiswanto University of Indonesia, Indonesia

Co-General Chair:

Prof. Ming Yang, Tokyo Metropolitan University, Japan

Dr. Ario Sunar Baskoro, University of Indonesia, Indonesia

Scientific and Program Chair:

Prof. Yukio Miyashita, Nagaoka University of Technology, Japan

Dr. Sugeng Supriadi, University of Indonesia, Indonesia

### The 4th Asian Symposium on Materials & Processing (ASMP2015)

#### REGISTRATION FORM:

Name: \_\_\_\_\_

Affiliation: \_\_\_\_\_

Address: \_\_\_\_\_

\_\_\_\_\_

Title of Paper: \_\_\_\_\_

\_\_\_\_\_

\_\_\_\_\_

E-mail: \_\_\_\_\_

Tel: \_\_\_\_\_

Fax: \_\_\_\_\_

**DEAD LINE:**  
28th February, 2015  
(Submission of Abstract)

Presentation:

Oral

Poster

Participant (Please check)